

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

DONALD C. ABBOTT ET AL.

Serial No. 09/525,105 (TI-28098.1)

Filed: Herewith

For: SEMICONDUCTOR CIRCUIT ASSEMBLY HAVING PLATED LEADFRAME
INCLUDING GOLD SELECTIVELY COVERING AREAS TO BE SOLDERED

Art Unit

Examiner

Director of the United States
Patent and Trademark Office
P.O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Dear Sir:

Prior to the first Office action, please amend the above-identified application as follows:

In the claims:

Cancel claims 1 to 16.

REMARKS

The claims elected in the parent application have been canceled, leaving claims 17 to 22 which were subject to a requirement for restriction in the parent application

Action and allowance are respectfully requested.

Respectfully submitted,



Texas Instruments Incorporated
P.O. Box 655474, M/S 3999
Dallas, TX 75265

Jay M. Cantor
Attorney for Applicant
Registration No. 19906
(301) 424-0355
(972) 917-5293